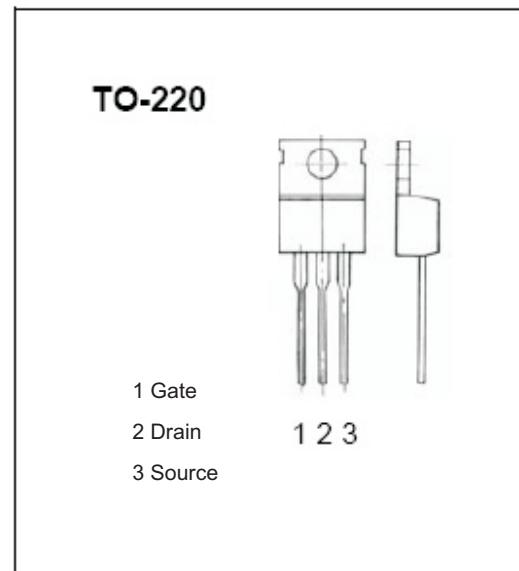
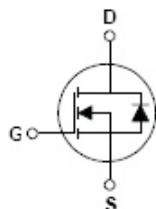


N-Channel MOSFET

KXP20N15

■ Features

- V_{DS} (V) = 150V
- $R_{DS(ON)}$ \leqslant 0.13Ω (V_{GS} = 10V)



■ Absolute Maximum Ratings T_a = 25°C

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DSS}	150	V
Gate source voltage	V_{GS}	± 20	V
Drain Current — Continuous	I_D	20	A
Drain Current - Pulsed (Note 2)	I_{DM}	60	A
Power dissipation @ $T_c=25$ °C - Derate above 25°C	P_D	112 0.9	W W/°C
Thermal resistance, junction - ambient	R_{thJA}	62.5	°C/W
Operating and storage temperature	T_j , T_{stg}	-55 to +150	°C

Note:1.Power rating when mounted on FR-4 glass epoxy printed circuit board using recommended footprint.

2.Pulse Test : Pulse width \leqslant 300μs, Duty cycle \leqslant 2%

N-Channel MOSFET

KXP20N15

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BVDSS	VGS = 0 V, ID = 250 μA	150			V
Gate Threshold Voltage	VGS(th)	VDS = VGS, ID = 250 μA	2.0		4.0	V
Gate-Body leakage current	IGSS	VGS = ±20 V, VDS = 0 V			±100	nA
Zero Gate Voltage Drain Current	IDSS	VDS = 150 V, VGS = 0 V			10	μA
Drain-Source On-State Resistance	RDS(on)	VGS = 10 V, ID = 10A			0.13	Ω
Forward Transconductance	gFS	VDS = 13 V, ID = 10 A	8	11		S
Total Gate Charge	Qg	VDS = 120V ,VGS = 10 V , ID=20A		39.1	55.9	nC
Gate-Source Charge	Qgs			7.5		
Gate-Drain Charge	Qgd			22		
Input Capacitance	Ciss	VDS =25V ,VGS = 0 , f = 1.0MHz		1133	1627	pF
Output Capacitance	Coss			332	474	
Reverse Transfer Capacitance	Crss			105	174	
Turn-On Delay Time	td(on)	VDD = 75V ,VGS=10V,RG = 9.1 Ω , ID = 20A		11	25	ns
Turn-On Rise Time	tr			77	153	
Turn-Off Delay Time	td(off)			33	67	
Turn-Off Fall Time	tf			49	97	
Drain-Source Diode Forward Voltage	VSD	VGS = 0 V, IS = 20A			1.5	V
Reverse Recovery Time	trr	VGS = 0 V, IS = 20A,dIS / dt = 100 A/μs		160		ns
Maximum Body-Diode Continuous Current	IS				20	A

■ Marking

Marking	20N15
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